Overview

HP Dragonfly Folio 13.5 inch G3 2-in-1

Left

1. Webcam

2. Webcam LED

3. Clickpad

4. Nano SIM card slot (WWAN module needed)

5. Thunderbolt™ 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4) [1]

6. Thunderbolt™ 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4) [1]

7. Vents

8. Audio Combo Jack

1. SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4.

Not all configuration components are available in all regions/countries.
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Overview

Right

1. Power Button
2. Vents
3. Pen Wireless Charging

4. HP Elite Dragonfly Folio G3 Pen
5. Pen Attach Slot

Not all configuration components are available in all regions/countries.
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Overview

At a Glance

- Preinstalled with Windows 11 versions or FreeDOS
- Empowering hands-on, visual, collaborative thinkers with the highly secure, intelligent, multi-mode HP Elite Dragonfly Folio
- Have natural interactions and move freely during calls with a wide field of view 8MP camera, quad speakers, and top edge mics, enhanced by HP Presence
- Whiteboarding and brainstorming ideas becomes a personalized experience with natural and intelligent inking that uses a magnetically attaching new HP Elite Dragonfly Folio pen that's always charged and ready
- Intelligent experiences from HP help conserve battery power with HP Auto Screen Dimming. Stay aware of shoulder surfers with HP Privacy Alert and reduce distractions during video calls with auto background blur.
- Choice of 12th generation Intel® Core™ i7, i5 U-series processors, including vPro options
- Display options, including OLED and award-winning Sure View, for life-like and comfortable viewing experience:
    - 13.5" diagonal, 3:2 WUXGA+, 400 nits, BrightView Touch, Corning® Gorilla® Glass 7
    - 13.5" diagonal, 3:2 WUXGA+, 400 nits, Anti-Glare Touch, Corning® Gorilla® Glass 7
    - 13.5" diagonal, 3:2 WUXGA+ Sure View Reflect, 1000 nits, BrightView Touch, Corning® Gorilla® Glass 7
    - 13.5" diagonal, 3:2 3k x 2k, 400 nits, OLED, BrightView Touch, Corning® Gorilla® Glass 7
- HP Wolf Security for Business creates a hardware-enforced, always-on, resilient defense
- Never wonder if someone is watching you with the added peace-of-mind of the HP Camera Privacy Key that turns your camera off with the touch of a button.
- Supports Wi-Fi 6E wireless LAN and up to 5G wireless WAN options for connectivity on the go
- Undergoes MIL-STD 810H tests
- Battery life up to TBD
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles

NOTE: See important legal disclosures for all listed specs in their respective features sections.

Not all configuration components are available in all regions/countries.
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PRODUCT NAME

HP Dragonfly Folio 13.5 inch G3 2-in-1 Notebook PC

OPERATING SYSTEMS

Preinstalled

Windows 11 Pro [1]
Windows 11 Pro Education [1]
Windows 11 Home – HP recommends Windows 11 Pro for Business [1]
Windows 11 Home Single Language – HP recommends Windows 11 Pro for Business [1]
Windows 11 Pro (Windows 11 Enterprise available with a Volume Licensing Agreement) [1]
Windows 10 Pro (available through downgrade rights from Windows 11 Pro) [1,2]
FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS

Processor [3,4,5,6]	Cores	Number of P-cores	Number of E-cores	Threads	L3 Cache	Max Turbo Frequency		Base Frequency		Intel SIPP/ vPro® Enterprise	Intel vPro® Essentials
						P-cores	E-cores	P-cores	E-cores		
Intel® Core™ i7-1265U	10	2	8	12	12MB	4.8 GHz	3.6 GHz	1.8 GHz	1.3 GHz	X	
Intel® Core™ i7-1255U	10	2	8	12	12MB	4.7 GHz	3.5 GHz	1.7 GHz	1.2 GHz		X
Intel® Core™ i5-1245U	10	2	8	12	12MB	4.4 GHz	3.3 GHz	1.2 GHz	1.2 GHz	X	
Intel® Core™ i5-1235U	10	2	8	12	12MB	4.4 GHz	3.3 GHz	1.3 GHz	0.9 GHz		X

Processor Family

12th Generation Intel® Core™ i7 processor (i7-1265U) [7]
12th Generation Intel® Core™ i7 processor (i7-1255U) [7]
12th Generation Intel® Core™ i5 processor (i5-1245U) [7]
12th Generation Intel® Core™ i5 processor (i5-1235U) [7]

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3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

5. Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro

6. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.

7. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated
Intel® Iris® Xᵉ Graphics [8]

8. Intel® Iris® Xᵉ Graphics capabilities require system to be configured with Intel® Core™ i5 or i7 processors and dual channel memory. Intel® Iris® Xᵉ Graphics with Intel® Core™ i5 or 7 processors and single channel memory will only function as UHD graphics.

DISPLAY

Touch
34.3 cm (13.5") diagonal, 3Kx2K (3000 x 2000), OLED touch, IPS, BrightView, Corning® Gorilla® Glass 7, 400 nits, DCI-P3 100% with HP Eye Ease [9,10,11,12]
34.3 cm (13.5") diagonal, WUXGA+ (1920 x 1280), touch, IPS, Anti-Glare, Corning® Gorilla® Glass 7, 400 nits, sRGB 100% with HP Eye Ease [9,10,11,12]
34.3 cm (13.5") diagonal, WUXGA+ (1920 x 1280), touch, IPS, BrightView, Corning® Gorilla® Glass 7, 400 nits, sRGB 100% with HP Eye Ease [9,10,11,12]
34.3 cm (13.5") diagonal, WUXGA+ (1920 x 1280), touch, IPS, BrightView, Corning® Gorilla® Glass 7, 1000 nits, HP Sure View Reflect integrated privacy screen, sRGB 100% with HP Eye Ease [9,10,11,12]

Displays support
Supports dual display through the dock

Display Size (Diagonal)
13.5"
34.3 cm (13.5")

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9. FHD/HD content required to view FHD/HD images.

10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

11. HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

12. Actual brightness will be lower with touchscreen or HP Sure View.

DOCKING (Sold Separately)

Docking station model #1	HP Thunderbolt 120W G4 Dock
Docking station model #2	HP Thunderbolt 280W G4 Dock
Docking station model #3	HP USB-C Dock G5
Docking station model #4	HP USB-C/A Universal Dock G2

STORAGE AND DRIVES

Primary M.2 Storage

2 TB PCIe® NVMe™ TLC SSD [13]

1 TB PCIe® NVMe™ TLC SSD [13]

512 GB PCIe® NVMe™ TLC Self Encrypted OPAL2 SSD [13]

512 GB PCIe® NVMe™ TLC SSD [13]

512 GB PCIe® NVMe™ Value SSD [13]

256 GB PCIe® NVMe™ TLC Self Encrypted OPAL2 SSD [13]

256 GB PCIe® NVMe™ TLC SSD [13]

13. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

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MEMORY

Maximum Memory
32 GB LPDDR5-6400 MHz RAM (on-board) [14,15]

Memory
32 GB LPDDR5-6400 MHz RAM (on-board) [14,15]
16 GB LPDDR5-6400 MHz RAM (on-board) [14,15]
8 GB LPDDR5-6400 MHz RAM (on-board) [14,15]

Memory Slots
Memory soldered down
Supports Dual Channel Memory

14. All slots are non-accessible / non-upgradeable.
15. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN
Intel® AX211 Wi-Fi 6E Bluetooth® 5.2 WLAN [16]
Intel® AX211 Wi-Fi 6E Bluetooth® 5.2 vPro WLAN [16,17]

WWAN
Intel® 5000 5G Solution WWAN [18]
Intel® XMM 7560 R+ LTE-Advanced Pro WWAN (Cat 16) [18]

Miracast
Native Miracast Support[19]

16. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.
17. Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro .
18. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.
19. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

Not all configuration components are available in all regions/countries.
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AUDIO/MULTIMEDIA

Audio

Audio by Bang & Olufsen

Discrete Amplifiers

Integrated Dual Top Edge Microphones

Quad Stereo Speakers

Speaker Power

1W per speaker

Camera

8MP + IR Camera with 100 Degree Ultrawide Viewing Angle and HP Camera Privacy Key

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, full-size, spill resistant

HP Premium Keyboard, full-size, privacy, spill resistant

Pointing Device

Clickpad with multi-touch gesture support

Function Keys

F1 - Display switching

F2 - Blank or Sure View

F3 - Brightness down

F4 - Brightness up

F5 - Audio mute

F6 - Volume down

F7 - Volume up

F8 - Mic Mute

F9 - Keyboard Backlight Brightness

F10 - Insert

F11 - Airplane Mode

F12 - HP Command Center

HP Camera Privacy Key

Power

Delete

Hidden Function Keys

Fn+R = Break

Fn+S = Sys Rq

Fn+C = Scroll Lock

Fn+W = Pause

Fn+E = Insert

Not all configuration components are available in all regions/countries.

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SOFTWARE AND SECURITY

Software

HP Quick Drop [20]

HP Easy Clean [21]

HP PC Hardware Diagnostics Windows

myHP [22]

HP Smart Support [23]

HP Connection Optimizer

HP Hotkey Support

HP Support Assistant [24]

HP Notifications

HP Auto Lock and Awake [25]

HP Privacy Settings

HP Power Manager [26]

Buy Microsoft Office (Sold separately)

Manageability Features

HP Image Assistant Gen5 (download)

HP Manageability Integration Kit (download) [27]

HP Client Management Script Library (download)

HP Driver Packs (download)

HP Cloud Recovery [28]

HP Client Catalog (download)

NOTE: To enhance brightness, level go to the Intel® Graphics Command Center app, click on System and turn off the Display Power Savings function.

Security Management

HP Wolf Security of Business [29] includes:

HP Sure Click [30]

HP Sure Sense [31]

HP Sure Run Gen5 [32]

HP Sure Recover Gen5 [33]

HP Sure Start Gen7 [34]

HP Tamper Lock

HP Sure Admin [35]

HP Client Security Manager Gen7 [36]

BIOS

HP BIOSphere Gen6 [37]

HP Secure Erase [38]

Absolute Persistence Module [39]

HP DriveLock & Automatic DriveLock

BIOS Update via Network

HP Wake on WLAN

TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)

Security

Not all configuration components are available in all regions/countries.

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TPM
Model: Infineon SLB9672VU2.0
Version: 15.21
Revision: TPM 2.0
FIPS 140-2 Compliant: Yes

IPv6 Support
Yes

FirstNet Certified
No

Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?: Yes
UEFI version: 2.7
Class: Class 3

20. HP Quick Drop requires Internet access and Windows 10 and higher PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

21. HP Easy Clean requires Windows 10 RS3 and higher and will disable the keyboard, touchscreen, and clickpad only. Ports are not disabled. See user guide for cleaning instructions.

22. myHP requires Windows OS.

23. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.

24. HP Support Assistance requires Windows and Internet Access.

25. Requires Windows 10 and higher and set up of facial recognition through Windows Hello.

26. HP Power Manager requires Windows 10 and higher and can be downloaded from the Microsoft Store.

27. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement and requires Microsoft Endpoint Manager.

28. HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and requires an open, wired network connection. Note: You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Detail please refer to: https://support.hp.com/us-en/document/c05115630.

29. HP Wolf Security for Business requires Windows 10 and higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

30. HP Sure Click requires Windows 10 Pro and higher. See https://bit.ly/2PrLT6A_SureClick for complete details.

31. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.

32. HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.

33. HP Sure Recover Gen5 with Embedded Reimaging is an optional feature which requires Windows 10 and higher must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module

34. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher

35. HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store

36. HP Client Security Manager Gen7 requires Windows and is available on the select HP Elite and Pro PCs.

37. HP BIOSphere Gen6 features may vary depending on the platform and configuration.

Not all configuration components are available in all regions/countries.
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38. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

39. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/

POWER

Power Supply
HP Smart 65 W USB Type-C® adapter, Standard [40]
HP Smart 65 W USB Type-C® adapter, Slim [40]

Battery
HP Long Life 4-cell, 53 Wh Polymer [41,42]
Compliant with UL 1642 Standard

Power Cord
Premium 3-wire plug - 1m
Standard 3-wire plug - 1m

Battery Life
Up to TBD [43]

40. Availability may vary by country.
41. Battery is internal and not replaceable by customer. Serviceable by warranty.
42. MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.
43. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

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WEIGHTS & DIMENSIONS

Product Weight [44]
Starting at 3.09 lbs
Starting at 1.40 kg

Product Dimensions (W x D x H)
11.67 x 9.22 x 0.70 in
29.64 x 23.43 x 1.79 cm

44. Weight will vary by configuration. Does not include power adapter.

PORTS/SLOTS

2 Thunderbolt™ 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4) [45]
1 Headphone/microphone combo jack
Nano SIM Slot (push push type)

45. SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4.

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SERVICE AND SUPPORT

1-year warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc. [46]

46. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

CERTIFICATION AND COMPLIANCE

Energy Efficiency Compliance:	ENERGY STAR® certified
Energy Efficiency Compliance:	EPEAT® 2019 Gold [47]
Environmental Specifications:	TCO 8.0 Certified
Certification:	RCTA DO-160G
Compliant:	Medical EMC: IEC 60601-1-2:2014 EN60601-1-2: 2015
Certification:	SEPA

47. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit http://www.epeat.net for more information.

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SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage	20V (Type-C)
Average Operating Power	
Integrated graphics	Yes
Discrete Graphics	N/A
Max Operating Power	UMA<65W

Temperature

Operating	32° to 95° F (0° to 35° C) (not writing optical)
Non-operating	41° to 95° F (5° to 35° C) (writing optical)

Relative Humidity

Operating	10% to 90%, non-condensing
Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating	40 G, 2 ms, half-sine
Non-operating	200 G, 2 ms, half-sine

Random Vibration

Operating	0.75 grams
Non-operating	1.50 grams

Altitude (unpressurized)

Operating	–50 to 10,000 ft (–15.24 to 3,048 m)
Non-operating	–50 to 40,000 ft (–15.24 to 12,192 m)

Planned Industry Standard Certifications

Regulatory Model Number	HSN-I55C
UL	Yes
CSA	Yes
FCC Compliance	Yes
ENERGY STAR®	Select models [48]
EPEAT®	EPEAT® Gold in United States [49]
TCO certified	Yes
ICES	Yes
Australia / NZ A-Tick Compliance	Yes
CCC	Yes
Japan VCCI Compliance	Yes
KC	Yes
BSMI	Yes
CE Marking Compliance	Yes
BNCI or BELUS	Yes
CIT	Yes
EAC Certificate	Yes
GOST	Yes
Saudi Arabian Compliance (ICCP)	Yes

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SABS	Yes

DISPLAYS

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or HP Sure View.

34.3 cm (13.5") diagonal, WUXGA+ (1920 x 1280), touch, IPS, BrightView, Corning® Gorilla® Glass 7, 400 nits, sRGB 100%		
	Outline Dimensions (W x H x D)	290.190 x 199.730 (max)
	Active Area	284.890 x 189.930 (typ)
	Weight	255 (max)
	Diagonal Size	13.5
	Thickness	2.1 / 3.9 (max)
	Interface	eDP 1.4
	Surface Treatment	Bright View
	Touch Enabled	Yes [1]
	Contrast Ratio	1500:1 (typ)
	Refresh Rate	60 Hz
	Brightness	400 nits
	Pixel Resolution - Format	1920 x 1280 (WUXGA+)
	Backlight	WLED
	Pixel Resolution	RGB
	Color Gamut Coverage	sRGB 100%
	Color Depth	8
	Viewing Angle	UWVA 89/89/89/89
	Low Blue Light	Yes
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.42 (max) / 1.71 (max)

34.3 cm (13.5") diagonal, 3Kx2K (3000 x 2000), OLED touch, IPS, BrightView, Corning® Gorilla® Glass 7, 400 nits, DCI-P3 100%		
	Outline Dimensions (W x H x D)	289.430 x 199.620 (max)
	Active Area	285.300 x 190.200 (typ)
	Weight	213 (max)
	Diagonal Size	13.5
	Thickness	1.242 / 3.242 (max)
	Interface	eDP 1.4
	Surface Treatment	BrightView
	Touch Enabled	Yes [1]

Not all configuration components are available in all regions/countries.
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Contrast Ratio	100,000:1(typ)
Refresh Rate	60 Hz
Brightness	400 nits [1]
Pixel Resolution - Format	3000 x 2000 (3k2k)
Backlight	OLED
Pixel Resolution	RGB
Color Gamut Coverage	DCI P3 100%
Color Depth	8
Viewing Angle	UWVA 85/85/85/85
Low Blue Light	Yes
Power Consumption (W, EBL@ 150nits max/ 200nits max)	4.15 (max) / 4.93 (m+H88+G85:G88

34.3 cm (13.5") diagonal, WUXGA+ (1920 x 1280), touch, IPS, BrightView, Corning® Gorilla® Glass 7, 1000 nits, HP Sure View Reflect integrated privacy screen, sRGB 100%	**Outline Dimensions (W x H x D)**	290.200 x 199.970 (max)
	Active Area	284.890 x 189.930 (typ)
	Weight	277.2 (max)
	Diagonal Size	13.5
	Thickness	2.2 / 3.9 (max)
	Interface	eDP 1.3
	Surface Treatment	Anti-Glare
	Touch Enabled	Yes [1]
	Contrast Ratio	1500:1 (typ)
	Refresh Rate	60 Hz
	Brightness	1000 nits [1]
	Pixel Resolution - Format	1920 x1280 (WUXGA+)
	Backlight	WLED
	Pixel Resolution	RGB
	Color Gamut Coverage	sRGB 100%
	Color Depth	8
	Viewing Angle	UWVA 85/85/85/85
	Low Blue Light	Yes
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	NA

34.3 cm (13.5") diagonal, WUXGA+ (1920 x 1280), touch, IPS, Anti-Glare, Corning® Gorilla® Glass 7, 400 nits, sRGB 100%	**Outline Dimensions (W x H x D)**	290.190 x 199.730 (max)
	Active Area	284.890 x 189.930 (typ)
	Weight	263 (max)
	Diagonal Size	13.5
	Thickness	2.1 / 3.9 (max)

Not all configuration components are available in all regions/countries.
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Interface	eDP 1.4
Surface Treatment	Anti-Glare
Touch Enabled	Yes [1]
Contrast Ratio	1500:1 (typ)
Refresh Rate	60 Hz
Brightness	400 nits [1]
Pixel Resolution - Format	1920 x1280 (WUXGA+)
Backlight	WLED
Pixel Resolution	RGB
Color Gamut Coverage	sRGB 100%
Color Depth	8
Viewing Angle	UWVA 89/89/89/89
Low Blue Light	Yes
Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.42 (max) / 1.71 (max)

Not all configuration components are available in all regions/countries.
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STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 11 and 10) is reserved for system recovery software.

256 GB PCIe® NVMe™ TLC Self Encrypted OPAL2 SSD		
	Form-Factor (I/O)	M.2 2280
	Capacity	256GB
	NAND Type	TLC
	Weight	0.02 lb (10 g)
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen4X4
	Sequential Read	4000MB/s ±20%
	Sequential Write	2000MB/s ±20%
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Security Features	TCG Opal 2.0

512 GB PCIe® NVMe™ TLC Self Encrypted OPAL2 SSD		
	Form-Factor (I/O)	M.2 2280
	Capacity	512GB
	NAND Type	TLC
	Weight	0.02 lb (10 g)
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen4X4
	Sequential Read	6400MB/s ±20%
	Sequential Write	3500MB/s ±20%
	Logical Blocks	1,000,215,216
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Security Features	TCG Opal 2.0
	Other Features	TRIM; L1.2

1 TB PCIe® NVMe™ TLC SSD		
	Form-Factor (I/O)	M.2 2280
	Capacity	1TB
	NAND Type	TLC
	Weight	0.02 lb (9 g)
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen4X4
	Sequential Read	6400MB/s ±20%

Not all configuration components are available in all regions/countries.
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	Sequential Write	5000MB/s ±20%
	Logical Blocks	2,000,409,264
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Security Features	Pyrite 2.0

256 GB PCIe® NVMe™ TLC SSD	**Form-Factor (I/O)**	M.2 2280
	Capacity	256 GB
	NAND Type	TLC
	Weight	0.02 lb (10 g)
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen4X4
	Sequential Read	4000MB/s ±20%
	Sequential Write	2000MB/s ±20%
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Security Features	Pyrite 2.0
	Other Features	TRIM; L1.2

2 TB PCIe® NVMe™ TLC SSD	**Form-Factor (I/O)**	M.2 2280
	Capacity	2TB
	NAND Type	TLC
	Weight	0.02 lb (10 g)
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen4X4
	Sequential Read	6400MB/s ±20%
	Sequential Write	5000MB/s ±20%
	Logical Blocks	4,000,797,360
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Security Features	Pyrite 2.0

512GB 2280 PCIe NVMe Value	**Form-Factor (I/O)**	M.2 2280
	Capacity	512 GB
	NAND Type	Vaule
	Weight	0.02 lb (10 g)
	Height	0.09 in (2.3 mm)

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Width	0.87 in (22 mm)
Interface	PCIe NVMe Gen3X2
Sequential Read	6400MB/s ±20%
Sequential Write	3500MB/s ±20%
Logical Blocks	1,000,215,216
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Security Features	Pyrite

512 GB PCIe® NVMe™ TLC SSD

Form Factor	M.2 2280
Capacity	512 GB
NAND Type	TLC
Height	0.02 lb (9 g)
Width	0.09 in (2.3 mm)
Weight	0.87 in (22 mm)
Interface	PCIe NVMe Gen4X4
Maximum Sequential Read	6400MB/s ±20%
Maximum Sequential Write	3500MB/s ±20%
Logical Blocks	1,000,215,216
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Features	Pyrite 2.0

Not all configuration components are available in all regions/countries.
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NETWORKING/COMMUNICATIONS

Intel® AX211 Wi-Fi 6E Bluetooth® 5.2 WLAN [1,5]		
Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v	
Interoperability	Wi-Fi certified	
Frequency Band	•802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz 5.955 – 6.415 GHz 6.435 – 6.515 GHz 6.535 – 6.875 GHz 6.895 – 7.115 GHz	
Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: max 300Mbps • 802.11ac : 1733Mbps • 802.11ax : max 2.4Gbps	
Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM	
Security[3]	• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • WPA3 certification • IEEE 802.11i • WAPI	
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)	
Roaming	IEEE 802.11 compliant roaming between access points	
Output Power[2]	• 802.11b : +17dBm minimum	

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	• 802.11g : +16dBm minimum	
	• 802.11a : +17dBm minimum	
	• 802.11n HT20(2.4GHz) : +14dBm minimum	
	• 802.11n HT40(2.4GHz) : +13dBm minimum	
	• 802.11n HT20(5GHz) : +14dBm minimum	
	• 802.11n HT40(5GHz) : +13dBm minimum	
	• 802.11ac VHT80(5GHz) : +10dBm minimum	
	• 802.11ac VHT160(5GHz) : +10dBm minimum	
	• 802.11ax HE40(2.4GHz) : +12dBm minimum	
	• 802.11ax HE80(5GHz) : +10dBm minimum	
	• 802.11ax HE160(5GHz) : +10dBm minimum	
Power Consumption	• Transmit mode 2.0 W	
	• Receive mode 1.6 W	
	• Idle mode (PSP) 180 mW (WLAN Associated)	
	• Idle mode 50 mW (WLAN unassociated)	
	• Connected Standby 10mW	
	• Radio disabled 8 mW	
Power Management	ACPI and PCI Express compliant power management	
	802.11 compliant power saving mode	
Receiver Sensitivity[4]	• 802.11b, 1Mbps : -93.5dBm maximum	
	• 802.11b, 11Mbps : -84dBm maximum	
	• 802.11a/g, 6Mbps : -86dBm maximum	
	• 802.11a/g, 54Mbps : -72dBm maximum	
	• 802.11n, MCS07 : -67dBm maximum	
	• 802.11n, MCS15 : -64dBm maximum	
	• 802.11ac, MCS0(VHT80) : -84dBm maximum	
	• 802.11ac, MCS9(VHT80) : -59dBm maximum	
	• 802.11ac, MCS9(VHT160) : -58.5dBm maximum	
	• 802.11ax, MCS11(HE40): -57dBm maximum	
	• 802.11ax, MCS11(HE80): -54dBm maximum	
	• 802.11ax, MCS11(HE160): -53.5dBm maximum	
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure	
	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications	
Form Factor	PCI-Express M.2 MiniCard	
Dimensions	1. Type 2230 : 2.3 x 22.0 x 30.0 mm	
	2. Type 1216: 1.67 x 12.0 x 16.0 mm	
Weight	1. Type 2230 : 2.8g	
	2. Type 1216: 1.3g	
Operating Voltage	3.3v +/- 9%	
Temperature	**Operating**	14° to 158° F (−10° to 70° C)
	Non-operating	−40° to 176° F (−40° to 80° C)
Humidity	**Operating**	10% to 90% (non-condensing)
	Non-operating	5% to 95% (non-condensing)
Altitude	**Operating**	0 to 10,000 ft (3,048 m)
	Non-operating	0 to 50,000 ft (15,240 m)

Not all configuration components are available in all regions/countries.
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LED Activity	LED Amber – Radio OFF; LED OFF – Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Technology

Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) BT5.2 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising

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2Mbps LE

LE Long Range

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation)

5. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

Intel® AX211 Wi-Fi 6E Bluetooth® 5.2 WLAN [1,5]	**Wireless LAN Standards**	IEEE 802.11a
		IEEE 802.11b
		IEEE 802.11g
		IEEE 802.11n
		IEEE 802.11ac
		IEEE 802.11ax
		IEEE 802.11d
		IEEE 802.11e
		IEEE 802.11h
		IEEE 802.11i
		IEEE 802.11k
		IEEE 802.11r
		IEEE 802.11v
	Interoperability	Wi-Fi certified
	Frequency Band	•802.11b/g/n/ax
		2.402 – 2.482 GHz
		•802.11a/n/ac/ax
		4.9 – 4.95 GHz (Japan)
		5.15 – 5.25 GHz
		5.25 – 5.35 GHz
		5.47 – 5.725 GHz
		5.825 – 5.850 GHz
		5.955 – 6.415 GHz
		6.435 – 6.515 GHz
		6.535 – 6.875 GHz
		6.895 – 7.115 GHz
	Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps
		• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
		• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
		• 802.11n: max 300Mbps
		• 802.11ac : 1733Mbps
		• 802.11ax : max 2.4Gbps
	Modulation	Direct Sequence Spread Spectrum

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	OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
Security[3]	• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
	• AES-CCMP: 128 bit in hardware
	• 802.1x authentication
	• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
	• WPA2 certification
	• WPA3 certification
	• IEEE 802.11i
	• WAPI
Network Architecture Models	Ad-hoc (Peer to Peer)
	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power[2]	• 802.11b : +17dBm minimum
	• 802.11g : +16dBm minimum
	• 802.11a : +17dBm minimum
	• 802.11n HT20(2.4GHz) : +14dBm minimum
	• 802.11n HT40(2.4GHz) : +13dBm minimum
	• 802.11n HT20(5GHz) : +14dBm minimum
	• 802.11n HT40(5GHz) : +13dBm minimum
	• 802.11ac VHT80(5GHz) : +10dBm minimum
	• 802.11ac VHT160(5GHz) : +10dBm minimum
	• 802.11ax HE40(2.4GHz) : +12dBm minimum
	• 802.11ax HE80(5GHz) : +10dBm minimum
	• 802.11ax HE160(5GHz) : +10dBm minimum
Power Consumption	• Transmit mode 2.0 W
	• Receive mode 1.6 W
	• Idle mode (PSP) 180 mW (WLAN Associated)
	• Idle mode 50 mW (WLAN unassociated)
	• Connected Standby 10mW
	• Radio disabled 8 mW
Power Management	ACPI and PCI Express compliant power management
	802.11 compliant power saving mode
Receiver Sensitivity[4]	• 802.11b, 1Mbps : -93.5dBm maximum
	• 802.11b, 11Mbps : -84dBm maximum
	• 802.11a/g, 6Mbps : -86dBm maximum
	• 802.11a/g, 54Mbps : -72dBm maximum
	• 802.11n, MCS07 : -67dBm maximum
	• 802.11n, MCS15 : -64dBm maximum
	• 802.11ac, MCS0(VHT80) : -84dBm maximum
	• 802.11ac, MCS9(VHT80) : -59dBm maximum
	• 802.11ac, MCS9(VHT160) : -58.5dBm maximum
	• 802.11ax, MCS11(HE40): -57dBm maximum
	• 802.11ax, MCS11(HE80): -54dBm maximum
	• 802.11ax, MCS11(HE160): -53.5dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure
	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

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Form Factor	PCI-Express M.2 MiniCard	
Dimensions	1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm	
Weight	1. Type 2230 : 2.8g 2. Type 1216: 1.3g	
Operating Voltage	3.3v +/- 9%	
Temperature	**Operating**	14° to 158° F (−10° to 70° C)
	Non-operating	−40° to 176° F (−40° to 80° C)
Humidity	**Operating**	10% to 90% (non-condensing)
	Non-operating	5% to 95% (non-condensing)
Altitude	**Operating**	0 to 10,000 ft (3,048 m)
	Non-operating	0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED OFF – Radio ON	

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2 Wireless Technology

Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software
Power Management Certifications	Microsoft Windows ACPI, and USB Bus Support FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Software Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full

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LE Privacy 1.2 –Link Layer Privacy
LE Privacy 1.2 –Extended Scanner Filter Policies
LE Data Packet Length Extension
FAX Profile (FAX)
Basic Imaging Profile (BIP)2
Headset Profile (HSP)
Hands Free Profile (HFP)
Advanced Audio Distribution Profile (A2DP)
BT5.2
ESR9/10 Compliance
LE Advertisement Extensions
Channel Selection Algo
Limited High Duty Cycle Non-Connectable Advertising
2Mbps LE
LE Long Range

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.
2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
3. Check latest software/driver release for updates on supported security features.
4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
5. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

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Intel® XMM 7560 R+ LTE-Advanced Pro WWAN (Cat 16) [1]		
	Technology/Operating bands	FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66), 600 (band 71). TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200 (Band 46 RX only) MHz; HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz
	Wireless protocol standards	3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW throughput up to 978Mbps; UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
	GPS	Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)
	GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
	Maximum data rates	LTE: 978 Mbps (Download), 150 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	Maximum output power	LTE: 23 dBm in all band except B41 LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm
	Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
	Form Factor	M.2, 3042-S3 Key B
	Weight	6 g
	Dimensions (Length x Width x Thickness)	42 x 30 x 2.3 mm
	eSIM	Support

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

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Intel® 5000 5G Solution WWAN [1]	Technology/Operating bands	WCDMA/HSPA+ operating bands:
		Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
		Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
		Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)
		Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
		Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
		LTE FDD/TDD operating bands:
		Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
		Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
		Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)
		Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)
		Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
		Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)
		Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
		Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL)
		Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL)
		Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL)
		Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL)
		Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL)
		Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL)
		Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)
		Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)
		Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL)
		Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)
		Band 29: 717 to 728 MHz (DL)
		Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL)
		Band 32: 1452 to 1496 MHz (DL)
		Band 34: 2010 to 2025 MHz (UL/DL)
		Band 38: 2570 to 2620 MHz (UL/DL)
		Band 39: 1880 to 1920 MHz (UL/DL)
		Band 40: 2300 to 2400 MHz (UL/DL)
		Band 41: 2496 to 2690 MHz (UL/DL)
		Band 42: 3400 to 3600 MHZ (UL/DL)
		Band 43: 3400 to 3800 MHZ (UL/DL)
		Band 46: 5150 to 5925 MHZ (DL)
		Band 48: 3550 to 3700 MHZ (UL/DL)
		Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL)
		Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)
		5GNR Sub 6GHZ
		n1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
		n2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
		n3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)
		n5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
		n7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)
		n8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
		n20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)
		n25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)
		n28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)
		n38: 2570 to 2620 MHz (UL/DL)

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	n40: 2300 to 2400 MHz (UL/DL)
	n41: 2496 to 2690 MHz (UL/DL)
	n48: 3550 to 3700 MHZ (UL/DL)
	n66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL)
	n71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)
	n77: 3300 to 4200 MHz (UL/DL)
	n78: 3300 to 3800 MHz (UL/DL)
	n79: 4400 to 5000 MHz (UL/DL)
Wireless protocol standards	5GNR Air Interface 3GPP Rel15 5G NR sub-6 LTE Rel14 20 layers and 2 Gbps downlink (DL) throughput – 4 × 4 MIMO across 5x CA 200 Mbps/uplink (UL) throughput – 40 MHz ULCA and 256 QAM WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
GPS	Standalone, A-GPS (MS-A, MS-B)
GPS bands	GPS: L1 (1575.42MHz) GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42) QZSS(1575.42 MHz)
Maximum data rates	SA 5G/NR sub-6 Peak: DL4.67Gbps/ UL 1.25Gbps 5G NSA sub 6G : DL: 3.8 Gbps/UL 700Mbps LTE: ue-CategoryDL 19, (DL : 1.6 Gbps) ue-CategoryUL 13 , (UL: 150Mbps) DC-HSPA+: 42 Mbps (Download), 11.5 Mbps (Upload)
Maximum output power	LTE: 23 dBm in all band except B41 LTE B41 HPUE = 26dBm NR: 23 dBm in all band except n41, n77, n78 and n79 LTE n41, n77, n78 and n79 HPUE = 26dBm HSPA+: 23.5 dBm
Maximum power consumption	5G Sub 6 : 2500 mA LTE: 1,300 mA (peak); 1100 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
Form Factor	M.2, 3042-S3 Key B
Weight	8 g
Dimensions (Length x Width x Thickness)	52 mm × 30 mm × 2.6 mm
eSIM	Support

1. Intel 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA

Not all configuration components are available in all regions/countries.
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technologies. 5G module planned to be available in select platforms and select countries, where carrier supported

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POWER

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

HP Smart 65 W USB Type-C® adapter, Standard	Dimensions (H x W x D)		88 x 53.5 x 21 mm
	Weight		unit: 220g +/- 10g
	Input	Input Efficiency	81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A
		Input frequency range	47 ~ 63 Hz
		Input AC current	1.6 A at 90 VAC and maximum load
	Output	Output power	65W
		DC output	5V/9V/12V/15V/20V
		Hold-up time	5ms at 115 Vac input
		Output current limit	<8.0A
	Connector		USB Type C
	Environmental Design	Operating temperature	32ºFto 95ºF (0ºto 35ºC)
		Non-operating (storage) temperature	–4ºFto 185ºF (-20ºto 85ºC)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	5% to 95%
		Storage Humidity	5% to 95%
	EMI and Safety Certifications		Eg: *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1 , Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.

HP Smart 65 W USB Type-C® adapter, Slim [44]	Dimensions (H x W x D)		90.0x51x28.5mm
	Weight		unit: 250g +/- 10g
	Input	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V : 81.5% 9V : 86.7%

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Technical Specifications

		12V : 88%
		15V : 88%
		20V : 89%
	Input frequency range	47 ~ 63 Hz
	Input AC current	Max. 1.6 A at 90 Vac
Output	**Output power**	65W
	DC output	5V/9V/12V/15V/20V
	Hold-up time	5ms at 115 Vac input
	Output current limit	<8.0A
Connector	USB TYPE C	
Environmental Design	**Operating temperature**	32°F to 95°F (0°to 35℃)
	Non-operating (storage) temperature	-4°F to 185°F (-20°to 85℃)
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
EMI and Safety Certifications	Eg: *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1 , Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE. * MTBF - over 200,000 hours at 25℃ ambient condition.	

HP 4-cell Long Life Li-Ion(53.2Wh)[1]	**Dimensions (H x W x D)**	5.90x102.70x208.20 mm
	Weight	241.5 g
	Cells/Type	4cell Lithium-Ion Polymer cell / 485083
	Energy	**Voltage**	8.7V
		Amp-hour capacity	6.910Ah
		Watt-hour capacity[1]	53.2Wh
	Temperature	**Operating (Charging)**	32˚ to 113˚ F (0˚ to 45˚ C)
		Operating (Discharging)	14˚ to 122˚ F (-10˚ to 60˚ C)
		Fuel Gauge LED	N/A
		Warranty	Refer to product warranty
		Optional Travel Battery Available	No

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Technical Specifications

AUDIO

HD Stereo Codec	Realtek ALC3315
Audio I/O Ports	Headset: CTIA only and Headphone-out
Internal Speaker Amplifier	CIRRUS CS35L51 Class D Amplifier
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent audio
Sampling	DAC:48kHz
	ADC:48kHz
Analog Audio	Support 3.5mm Headset: CTIA only and Headphone-out
Internal Speaker	Yes

COUNTRY OF ORIGIN

China

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Options and Accessories (Sold separately and availability may vary by country)

DOCKING (Sold Separately)

Docking station model #1	HP Thunderbolt 120W G4 Dock
Total number of supported displays (incl. the notebook display)	4
Max. resolutions supported	Quad 4K @60Hz
	Dual 8K single cable@30 for TB hosts or USB-C hosts DP 1.4 with DSC in high res mode
Dock Connectors	2xDP, 1xHDMI, 1xTB, 1xUSB-C Alt Mode
Technical limitations	Maximum resolution and display support is dependent on the maximum capability of the notebook.
	Thunderbolt Hosts:
	Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host.
	Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz
	Non-Thunderbolt hosts:
	The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is
	(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port
	Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.
Docking station model #2	HP Thunderbolt 280W G4 Dock
Total number of supported displays (incl. the notebook display)	4
Max. resolutions supported	Quad 4K @60Hz
	Dual 8K single cable@30 for TB hosts or USB-C hosts DP 1.4 with DSC in high res mode
Dock Connectors	2xDP, 1xHDMI, 1xTB, 1xUSB-C Alt Mode
Technical limitations	Maximum resolution and display support is dependent on the maximum capability of the notebook.
	Thunderbolt Hosts:
	Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host.
	Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz
	Non-Thunderbolt hosts:
	The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is
	(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port
	Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.

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Options and Accessories (Sold separately and availability may vary by country)

Docking station model #3	HP USB-C Dock G5
Total number of supported displays (incl. the notebook display)	3
Max. resolutions supported	Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode)
Dock Connectors	1xHDMI, 2xDP
Technical limitations	Maximum resolution and display support is dependent on the maximum capability of the notebook.

Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.
Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode
The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port . |
Docking station model #4	HP USB-C/A Universal Dock G2
Total number of supported displays (incl. the notebook display)	3
Max. resolutions supported	Triple 4K UHD@ 60Hz
Dock Connectors	1xHDMI, 2xDP
Technical limitations	Maximum resolution and display support is dependent on the maximum capability of the notebook.

The best resolution for dual or triple displays is 4K UHD@ 60Hz.
For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the host |

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Options and Accessories (Sold separately and availability may vary by country)

Type	Description	Part Number
Audio/Video	HP 3.5mm G2 Stereo Headset	428H6AA
	HP 445 BT w/USB-C+3.5mm cl Conf On-Ear Headset	689J7AA
Cases	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA
	HP Renew Executive 16" Laptop Backpack	6B8Y1AA
	HP Renew Executive 16" Laptop Bag	6B8Y2AA
	HP Renew Executive 14.1 Laptop Sleeve	6B8Y3AA
	HP Renew Business 14.1 Laptop Bag	3E5F9AA
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
Docking	HP Thunderbolt 120W G2 Dock	2UK37AA
	HP Thunderbolt 120W G2 Dock w/Audio	3YE87AA
	HP Thunderbolt 120W G4 Dock	4J0A2AA
	HP Thunderbolt 230W G2 Dock w/Combo Cable	3TR87AA
	HP Thunderbolt 280W G4 Dock w/Combo Cable	4J0G4AA
	HP USB-C 120W G5 Dock	5TW10AA
	HP USB-C/A 120W G2 Universal Dock	5TW13AA
Hub	HP USB-C Mini Dock	1PM64AA
	HP Universal USB-C Multiport Hub	50H55AA
	HP USB-C Travel Dock G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
Adapter	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to RJ45 Adapter	V7W66AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
Keyboard/Combo	HP 975 Dual-Mode Wireless Keyboard	3Z726AA
	HP Travel Bluetooth Mouse	6SP30AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA
	HP Creator 935 Wireless Mouse Black	1D0K8AA
	HP 65W USB-C Portable Laptop Charger	468T0AA

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Change Log

Date of change:	Version History:		Description of change:
September 7, 2022	V1 to V2	Removed	Tile App
	V2 to V3		

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